Storage SuperServer SSG-121E-NE316R



Key Applications

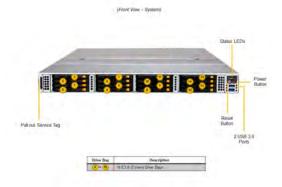
Software-defined Storage, In-Memory Computing, Data Intensive HPC, Private & Hybrid Cloud, NVMe Over Fabrics Solution,

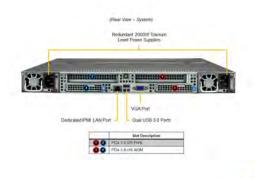
Key Features

- Dual Socket E (LGA-4677) 4th Generation Intel® Xeon® Scalable processors. Up to 270W TDP.;
- Supports 32 DIMMs with 2DPC, up to 12TB memory capacity with 16 DIMMs of 256Gb 3DS RDIMM/RDIMM DDR5 ECC memory and 16 DIMMs of 512Gb Intel® Optane PMem 300 Series;
- Two PCIe 5.0 x16 slots & two AIOM connectors (OCP 3.0 SFF compliant);
- 16x hot-swap E3.S (7.5mm) NVMe drive bays;
- Redundant Titanium 1600W Power Supplies;



1U Rackmount
Enclosure: 438.4 x 43.6 x 773.25mm (17.2" x 1.7" x 30.4")
Package: 604.774 x 199.898 x 1029.97mm (23.81" x 7.87" x 40.55")
Dual Socket E (LGA-4677)
4th Gen Intel® Xeon® Scalable processors
Supports 145W - 270W TDP CPUs (Air Cooled)
Memory Capacity: 32 DIMM slots
Up to 4TB: 16x 256 GB DRAM
Up to 8TB: 32x 256 GB DRAM
Memory Type: 4800MHz ECC DDR5 RDIMM;LRDIMM
16x E3.S Hot-swap NVMe (7.5mm) drive slots
2x PCIe 3.0 (NVMe or SATA3 Hybrid slots)
M-Key, 2280 and 22110
2 PCIe 5.0 x16 FH slot(s)
2 PCIe 5.0 x16 AIOM slot(s)
Chipset: Intel® C741
Network Connectivity: Via AIOM
IPMI: Support for Intelligent Platform Management Interface v.2.0
IPMI 2.0 with virtual media over LAN and KVM-over-LAN support
LAN: 1 RJ45 Dedicated IPMI LAN port
USB: 4 USB 3.0 port(s) (2 rear; 2 front)
Video: 1 VGA port(s)





System Cooling	8x 4cm heavy duty fan(s)
Power Supply	2000W Redundant Titanium Level power supplies
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	Redfish API; Supermicro Server Manager (SSM); Supermicro Power Manager (SPM); Supermicro Update Manager (SUM); SuperDoctor® 5; Super Diagnostics Offline; KVM with dedicated LAN; IPMI 2.0
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory 4+1 Phase-switching voltage regulator FAN: Fans with tachometer monitoring Status monitor for speed control Pulse Width Modulated (PWM) fan connectors Temperature: Monitoring for CPU and chassis environment Thermal Control for fan connectors
Dimensions and Weight	Height: 1.7" (43.6 mm) Width: 17.2" (438.4 mm) Depth: 30.4" (773.25 mm) Gross Weight: 68.74 lbs (31.2 kg) Net Weight: 48 lbs (21.8 kg) Packaging: 7.87" (H) x 23.81" (W) x 40.55" (D) Available Color: Silver
Operating Environment	ROHS: RoHS Compliant Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) Operating Relative Humidity: 8% to 90% (Non-condensing) Non-operating Relative Humidity: 8% to 95% (Non-condensing)
Motherboard	Super X13DSF-A
Chassis	CSE-126E32-R1K62P